



THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Bernd Borchert
Serial No.: 09/944,823
Filed: August 31, 2001
For: SEMICONDUCTOR LASER CHIP AND METHOD FOR
FABRICATING A SEMICONDUCTOR LASER CHIP
Confirmation No.: 3378
Group Art Unit: 2828
Examiner: Delma R. Flores Ruiz
Attorney Docket No.: 32226.12
Additional Fees: Charge to Deposit Account 023732

Mail Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir or Madam:

AMENDMENT AND RESPONSE

This paper is being filed in response to the Office Action mailed December 3, 2003.
Please amend the above-identified application as follows:

CERTIFICATE OF MAILING

I hereby certify that this document is being deposited with the United States Postal Service as First Class Mail, in an envelope addressed to Mail Stop Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date indicated below.

By Am Postad
Date 3/21/09